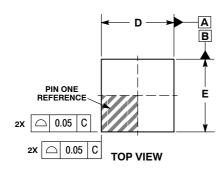
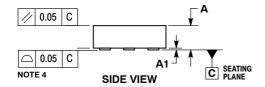
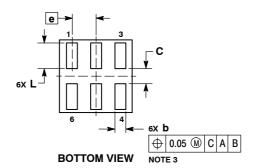


**XDFN6 1.2x1.2, 0.4P**CASE 711AA-01
ISSUE O

**DATE 12 OCT 2010** 







## NOTES:

- DIMENSIONING AND TOLERANCING PER
   ASME VIA FM 1994
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25mm FROM TERMINAL TIPS.
- 0.15 AND 0.25mm FROM TERMINAL TIPS.
   COPLANARITY APPLIES TO ALL OF THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.40	
A1	0.00	0.05	
b	0.13	0.23	
С	0.20	0.30	
D	1.20 BSC		
E	1.20 BSC		
е	0.40 BSC		
L	0.37	0.48	

## GENERIC MARKING DIAGRAM\*

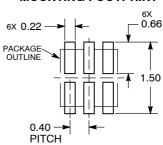


XX = Specific Device Code

MM = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present.

## RECOMMENDED MOUNTING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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98A0N53185	F

PAGE 2 OF 2

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